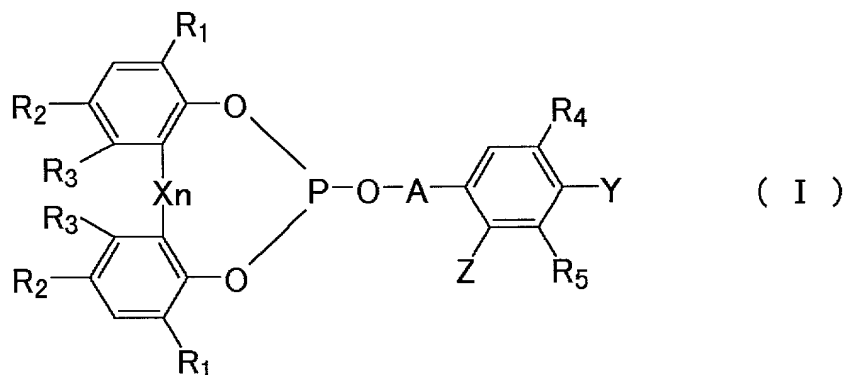


ABSTRACT OF THE DISCLOSURE

A polypropylene resin composition for a film for metallization, which comprises 100 parts by weight of a polypropylene resin and 0.01 to 1 part by weight of a phosphite represented by the general formula (I):



(wherein, R^1 , R^2 , R^4 and R^5 represent individually hydrogen, an alkyl, cycloalkyl, alkylcycloalkyl, aralkyl or phenyl; R^3 represents hydrogen or an alkyl; X represents sulfur atom or a $-CHR^6-$ group (R^6 represents hydrogen, an alkyl or cycloalkyl); n is 0 or 1; A is an alkylene or a $^*-CO(R^7)_m-$ group (R^7 is an alkylene, * mark is indicative of the bonding site of A to oxygen and m is 0 or 1); and either one of Y or Z is hydroxy, alkoxy or aralkyloxy and the other is hydrogen or an alkyl.), a film thereof, and a metallized film thereof.